As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

□ is attached hereto.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled WAFER BACK SIDE COATING TO BALANCE STRESS FROM PASSIVATION LAYER ON FRONT OF WAFER AND BE USED AS A DIE ATTACH ADHESIVE, the specification of which (check one):

us filed on as United States application serial no and was amended on						
□ was filed on as	PCT international application no	and was amended under PCT Article 19 on				
I hereby state that I have reviewed referred to above.	d and understand the contents of the above	ve-identified specification	n, including the claims, as amend	ded by any an	nendment	
_ •	e to the U.S. Patent and Trademark Office "materiality" is defined in Title 37, Cod		•	ntability of th	e subject	
certificate or § 365(a) of any PCT intattached continuation page and have a	enefits under Title 35, United States Code ternational application(s) designating at least identified below and on any attached gnating at least one country other than the	east one country other the long the continuation page any f	an the United States of America foreign application for patent or	listed below inventor's cer	and on any tificate or an	
Prior foreign/PCT application(s):			P		iority Claimed	
(number)	(coun	try)	(day/month/year filed)	Yes	No	
(number)	(coun	try)	(day/month/year filed)	Yes	No	
(application serial no.)	(filing date)		(status - pending, patented or abandoned)			
(application serial no.)	(filing date)		(status - pending, patented or abandoned)			
I hereby claim the benefit under T	Citle 35, United States Code, § 119(e) of (filing date)	any United States provis	sional application(s) listed below	:		
I hereby appoint the following Reg therewith:	gistered Practitioners to prosecute this ap	oplication and to transact	all business in the Patent and Ti	rademark Offi	ice connected	
David V. Trask, Reg. No. 22,012 Joseph A. Walkowski, Reg. No. 2 Allen C. Turner, Reg. No. 33,041 Bruce E. Hayden, Reg. No. 35,53 Devin R. Jensen, Reg. No. 44,805 Reg. No. 42,627 Bradley B. Jensen, Reg. No. 46,86 Michael L. Lynch, Reg. No. 30,87	8,765 James R. Duzan, Reg. No. Edgar R. Cataxinos, Reg. No. Brick G. Power, Reg. No. Krista Weber Powell, Reg. Bretton L. Crockett, Reg. No. Andrew F. Nilles, Reg. No.	28,393 H No. 39,931 K 38,581 P: No. 47,867 D No. 44,632 . 47,825 K	aurence B. Bond, Reg. No. 30,5 I. Dickson Burton, Reg. No. 48,5 Ient S. Burningham, Reg. No. 30 aul C. Oestreich, Reg. No. 44,9 avid L. Stott, Reg. No. 43,937 atherine A. Hamer, Reg. No. 47	396),453 83 Shawn (G. Hansen,	
Address all correspondence to:	James R. Duzan, telephone no. (801 TRASKBRITT P.O. BOX 2550 Salt Lake City, Utah 84110) 532-1922.				
and further that these statements were	s made herein of my own knowledge are made with the knowledge that willful fa of the United States Code and that such v	ilse statements and the li	ke so made are punishable by fir	ne or imprisor	nment, or	

2-11-02

Date

Citizenship: U.S.A.
Post Office Address: 450 Grove SAtreet, #409, Boise, ID 83702

Full name of first joint inventor: Michael E. Connell

issued thereon.

Inventor's signature

Residence: Boise, Idaho

DECLARATION FOR PATENT APPLICATION

(continuation page)

Invention title: WAFER BACK SIDE COATING TO BALANCE STRESS FROM PASSIVATION LAYER ON FRONT OF WAFER AND BE USED AS A DIE ATTACH ADHESIVE

Inventor name(s) appearing on first declaration page: Michael E. Connell

Additional original, first and joint inventor(s):

Full name of second joint inventor: Tongbi Jiang
Inventor's signature

Date

2/11/02

Residence: Boise, Idaho Citizenship: U.S.A.

Post Office Address: 12036 W. Patrina Drive, Boise, ID 83713



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Michael E. Connell and Tongbi Jiang

Examiner:

Unknown Unknown

Serial No.: Not yet assigned Filed:

Group Art Unit:

Title:

Attorney Docket No.: 5083US (01-0428) WAFER BACK SIDE COATING TO BALANCE STRESS FROM PASSIVATION LAYER ON FRONT OF WAFER AND BE

USED AS A DIE ATTACH ADHESIVE

POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE UNDER 37 CFR § 3.73(b)

Commissioner for Patents Washington, D.C. 20231

Sir:

MICRON TECHNOLOGY, INC., assignee of the entire right, title and interest by assignment from the inventor(s) in the aboveidentified application, hereby appoints the following attorneys and agents:

David V. Trask, Reg. No. 22,012 Joseph A. Walkowski, Reg. No. 28,765 Allen C. Turner, Reg. No. 33,041 Bruce E. Hayden, Reg. No. 35,539 Devin R. Jensen, Reg. No. 44,805 Shawn G. Hansen, Reg. No. 42,627 Andrew F. Nilles, Reg. No. 47,825 Charles B. Brantley II, Reg. No. 38,086

William S. Britt, Reg. No. 20,969 James R. Duzan, Reg. No. 28,393 Edgar R. Cataxinos, Reg. No. 39,931 Brick G. Power, Reg. No. 38,581 Krista Weber Powell, Reg. No. 47,867 Bretton L. Crockett, Reg. No. 44,632 Katherine A. Hamer, Reg. No. 47,628

Laurence B. Bond, Reg. No. 30,549 H. Dickson Burton, Reg. No. 48,396 Kent S. Burningham, Reg. No. 30,453 Paul C. Oestreich, Reg. No. 44,983 David L. Stott, Reg. No. 43,937 Bradley B. Jensen, Reg. No. 46,801 Michael L. Lynch, Reg. No. 30,871

as its attorneys with full power of substitution to prosecute this application and all applications claiming filing date priority therefrom and to transact all business in the U.S. Patent and Trademark Office in connection therewith.

The above-identified assignee hereby elects, pursuant to 37 C.F.R. § 3.71, to conduct the prosecution of the above-identified patent application to the exclusion of the inventor(s).

A chain of title from the inventor(s) of the above-identified patent application to the above-identified assignee is shown:

- [] In an assignment recorded in the U.S. Patent and Trademark Office at Reel, Frame.
- [x] In an assignment filed herewith for recordation, a true copy of which is attached hereto.

The undersigned has reviewed the above-identified assignment and, to the best of his knowledge and belief, title is in the above-identified assignee.

The undersigned further avers that he is empowered to make and sign the foregoing certification on behalf of the above-identified assignee, and to take the action set forth herein on its behalf.

Please direct all communications regarding the above-identified application to:

James R. Duzan, TRASKBRITT, PC P.O. Box 2550 Salt Lake City, UT 84110 Tele: (801) 532-1922 Fax: (801) 531-9168

Respectfully Submitted,

MICRON TECHNOLOGY, INC.

Date: 2-13-2002

Michael L. Lynch, Esq. Reg. No. 30,871

Chief Patent Counsel, MICRON TECHNOLOGY, INC.